



High-end Power Semiconductor Manufacturer

# KP250A 4600V-6500V Phase Control Thyristor

- High power cycling capability
- Low on-state and switching losses
- Designed for traction and industrial applications



Mean on-state current	$I_{TAV}$		250 A									
Repetitive peak off-state voltage	$V_{DRM}$		4600 – 6500 V									
Repetitive peak reverse voltage	$V_{RRM}$											
Turn-off time	$t_q$		630 $\mu$ s									
$V_{DRM}, V_{RRM}, V$	4600	4800	5000	5200	5400	5600	5800	6000	6200	6400	6500	
Voltage code	46	48	50	52	54	56	58	60	62	64	65	
$T_j, ^\circ C$	-60 – 125											

## MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
$I_{TAV}$	Mean on-state current	A	250	$T_c=85^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz	
$I_{TRMS}$	RMS on-state current	A	392.5	$T_c=85^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz	
$I_{TSM}$	Surge on-state current	kA	4.5 5.0	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; 50 Hz ( $t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			5.0 6.0		
$I^2t$	Safety factor	$A^2s \cdot 10^3$	100 125	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; 50 Hz ( $t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			125 145		
<b>BLOCKING</b>					
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	4600–6500	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; 50 Hz; Gate open	
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	4700–6600	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; 50 Hz; single pulse; Gate open	
$V_D, V_R$	Direct off-state and Direct reverse voltages	V	$0.75 \cdot V_{DRM}$ $0.75 \cdot V_{RRM}$	$T_j=T_{jmax}$ ; Gate open	

<b>TRIGGERING</b>				
$I_{FGM}$	Peak forward gate current	A	8	$T_j = T_{j\ max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	4	$T_j = T_{j\ max}$ for DC gate current
<b>SWITCHING</b>				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/ $\mu$ s	500	$T_j = T_{j\ max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 2 I_{TAV};$ Gate pulse: $I_G = 2\ A;$ $t_{GP} = 50\ \mu s; di_G/dt \geq 1\ A/\mu s$
<b>THERMAL</b>				
$T_{stg}$	Storage temperature	$^{\circ}C$	-60 – 125	
$T_j$	Operating junction temperature	$^{\circ}C$	-60 – 125	
<b>MECHANICAL</b>				
F	Mounting force	kN	14.0 – 16.0	
a	Acceleration	$m/s^2$	50 100	Device unclamped Device clamped

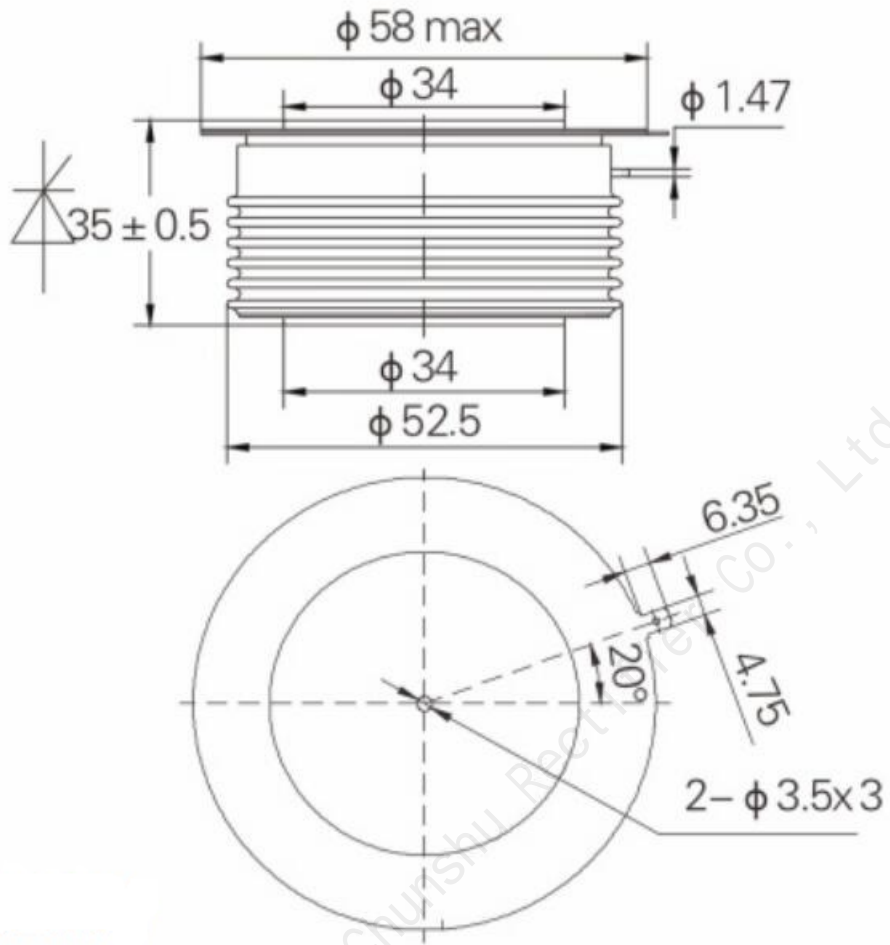
## CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
<b>ON-STATE</b>					
$V_{TM}$	Peak on-state voltage, max	V	2.90	$T_j = 25\ ^{\circ}C; I_{TM} = 785\ A$	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.15	$T_j = T_{j\ max};$	
$r_T$	On-state slope resistance, max	$m\Omega$	2.520	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
$I_L$	Latching current, max	mA	700	$T_j = 25\ ^{\circ}C; V_D = 12\ V;$ Gate pulse: $I_G = 2\ A;$ $t_{GP} = 50\ \mu s; di_G/dt \geq 1\ A/\mu s$	
$I_H$	Holding current, max	mA	300	$T_j = 25\ ^{\circ}C;$ $V_D = 12\ V; \text{ Gate open}$	
<b>BLOCKING</b>					
$I_{DRM}, I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	150	$T_j = T_{j\ max};$ $V_D = V_{DRM}; V_R = V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	1000	$T_j = T_{j\ max};$ $V_D = 0.67 \cdot V_{DRM}; \text{ Gate open}$	
<b>TRIGGERING</b>					
$V_{GT}$	Gate trigger direct voltage, max	V	2.50 2.00	$T_j = 25\ ^{\circ}C$ $T_j = T_{j\ max}$	$V_D = 12\ V; I_D = 3\ A;$ Direct gate current
$I_{GT}$	Gate trigger direct current, max	mA	300 200	$T_j = 25\ ^{\circ}C$ $T_j = T_{j\ max}$	
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.35	$T_j = T_{j\ max};$ $V_D = 0.67 \cdot V_{DRM};$	
$I_{GD}$	Gate non-trigger direct current, min	mA	15.00	Direct gate current	
<b>SWITCHING</b>					
$t_{gd}$	Delay time	$\mu$ s	4.00	$T_j = 25\ ^{\circ}C; V_D = 0.4 \cdot V_{DRM}; I_{TM} = I_{TAV};$ Gate pulse: $I_G = 2\ A;$ $t_{GP} = 50\ \mu s; di_G/dt \geq 1\ A/\mu s$	
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	630	$dv_D/dt = 50\ V/\mu s; T_j = T_{j\ max}; I_{TM} = 1000\ A;$ $di_R/dt = -10\ A/\mu s; V_R = 100V;$ $V_D = 2000\ V$	
$Q_{rr}$	Total recovered charge, max	$\mu$ C	3500	$T_j = T_{j\ max}; I_{TM} = 1000\ A;$	
$t_{rr}$	Reverse recovery time, typ	$\mu$ s	50	$di_R/dt = -5\ A/\mu s;$	
$I_{rrM}$	Peak reverse recovery current, max	A	140	$V_R = 100\ V$	

<b>THERMAL</b>					
$R_{thjc}$	Thermal resistance, junction to case, max	°C/W	0.0450	Direct current	Double side cooled
$R_{thjc-A}$			0.0990		Anode side cooled
$R_{thjc-K}$			0.0810		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	°C/W	0.0075	Direct current	
<b>MECHANICAL</b>					
w	Weight, typ	g	400		
$D_s$	Surface creepage distance	mm (inch)	38.00 (1.496)		
$D_a$	Air strike distance	mm (inch)	21.00 (0.827)		

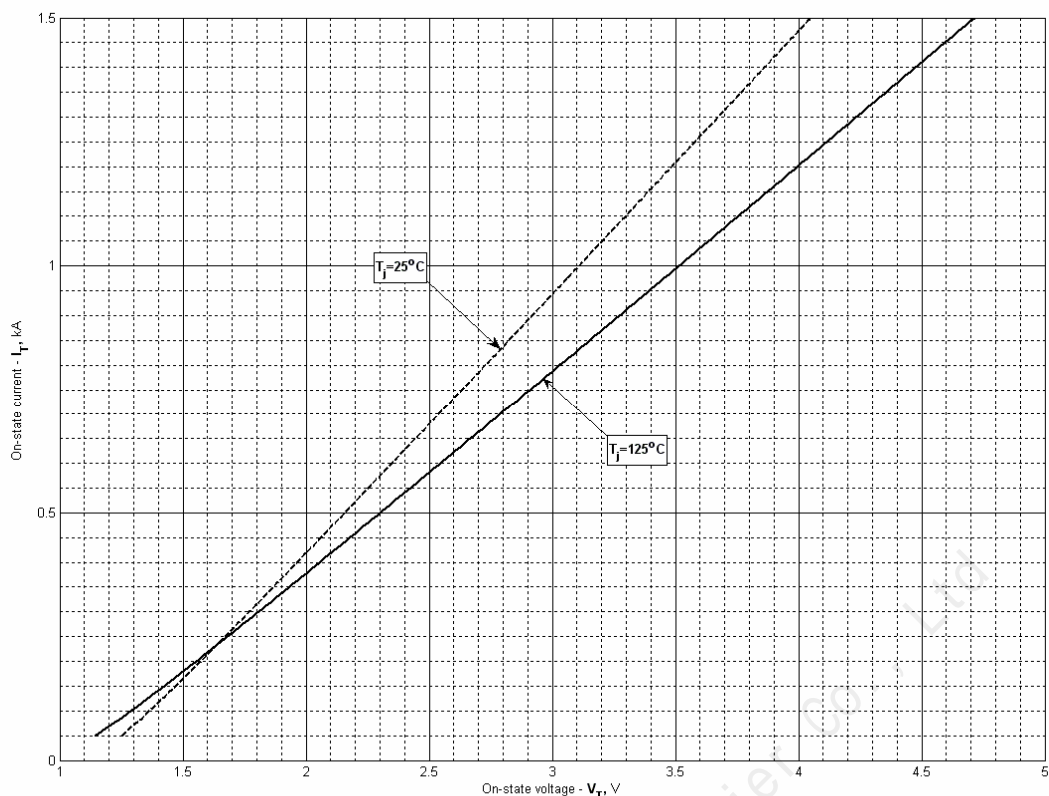
Beijing Xinchuang Chunshu Rectifier Co., Ltd

OVERALL DIMENSIONS



KT40DT

All dimensions in millimeters



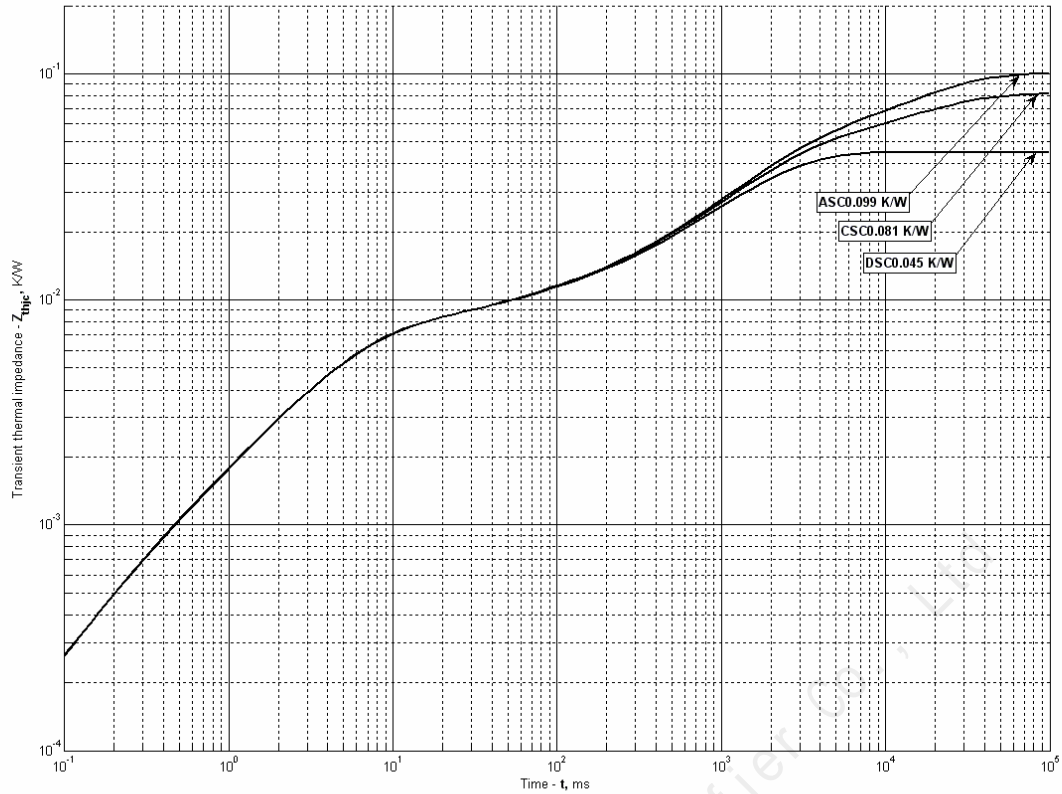
**Fig 1 – On-state characteristics of Limit device**

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j\text{max}}$
<b>A</b>	1.100009	0.947147
<b>B</b>	1.839506	2.342629
<b>C</b>	-0.218225	-0.291455
<b>D</b>	0.318651	0.425581

**On-state characteristic model (see Fig. 1)**



**Fig 2 – Transient thermal impedance**

Analytical function for Transient thermal impedance junction to case  $Z_{thjc}$  for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left( 1 - e^{-\frac{t}{\tau_i}} \right)$$

Where  $i = 1$  to  $n$ ,  $n$  is the number of terms in the series.

$t$  = Duration of heating pulse in seconds.

$Z_{thjc}$  = Thermal resistance at time  $t$ .

$R_i$  = Amplitude of  $p_{th}$  term.

$\tau_i$  = Time constant of  $r_{th}$  term.

DC Double side cooled

$i$	1	2	3	4	5	6
$R_i$ K/W	0.0003324	0.003816	0.00345	0.002093	0.001185	0.03412
$\tau_i$ s	0.0002588	0.003593	0.006835	0.06337	0.4078	1.714

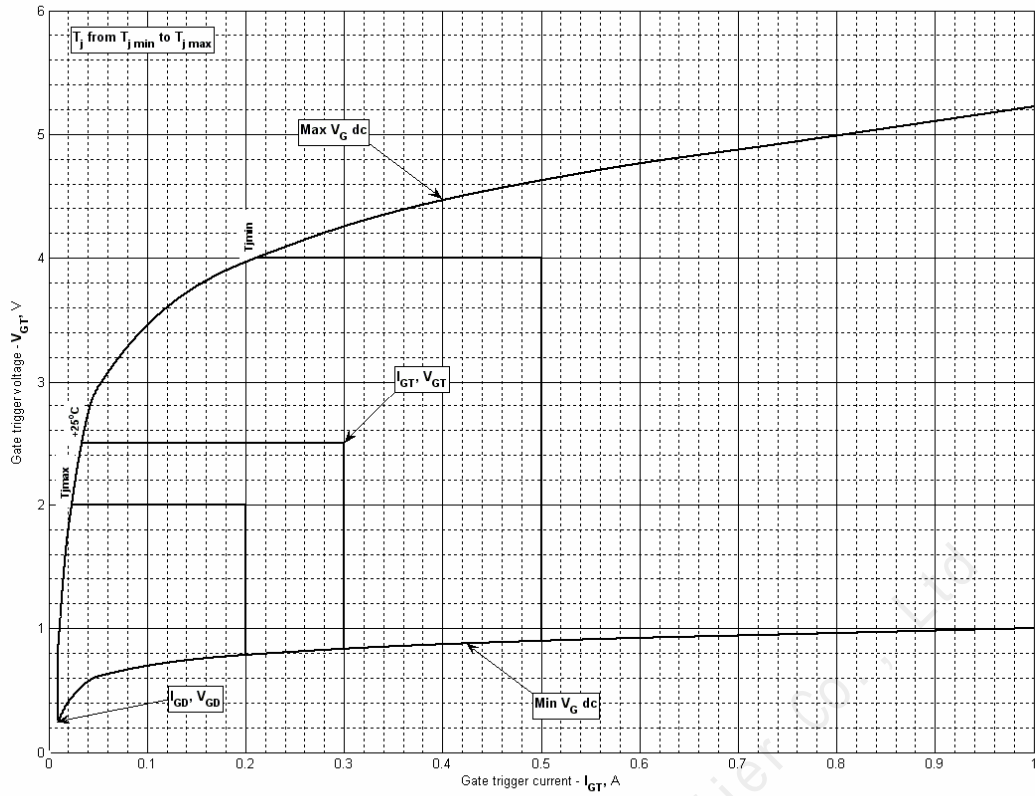
DC Cathode side cooled

$i$	1	2	3	4	5	6
$R_i$ K/W	0.0004152	0.006772	0.001903	0.001399	0.03451	0.03653
$\tau_i$ s	0.0003214	0.004599	0.03962	0.2053	1.810	17.69

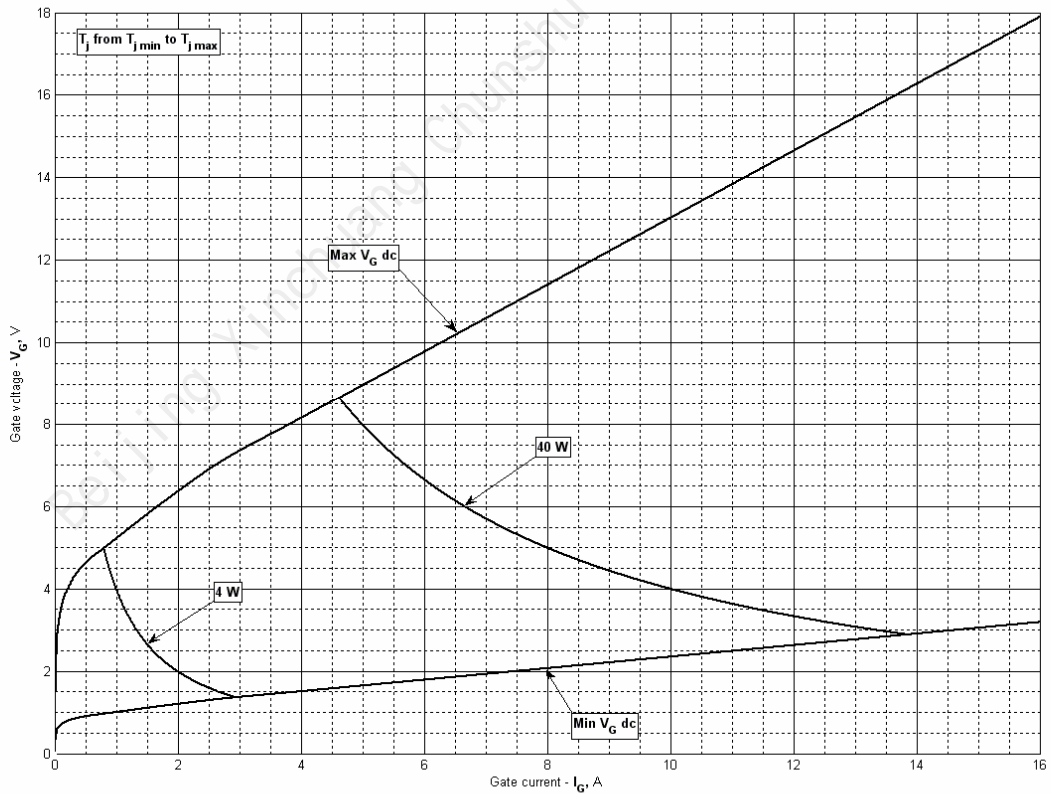
DC Anode side cooled

$i$	1	2	3	4	5	6
$R_i$ K/W	0.0004076	0.006732	0.001746	0.001465	0.03471	0.05539
$\tau_i$ s	0.0003146	0.004563	0.03539	0.1651	1.871	17.71

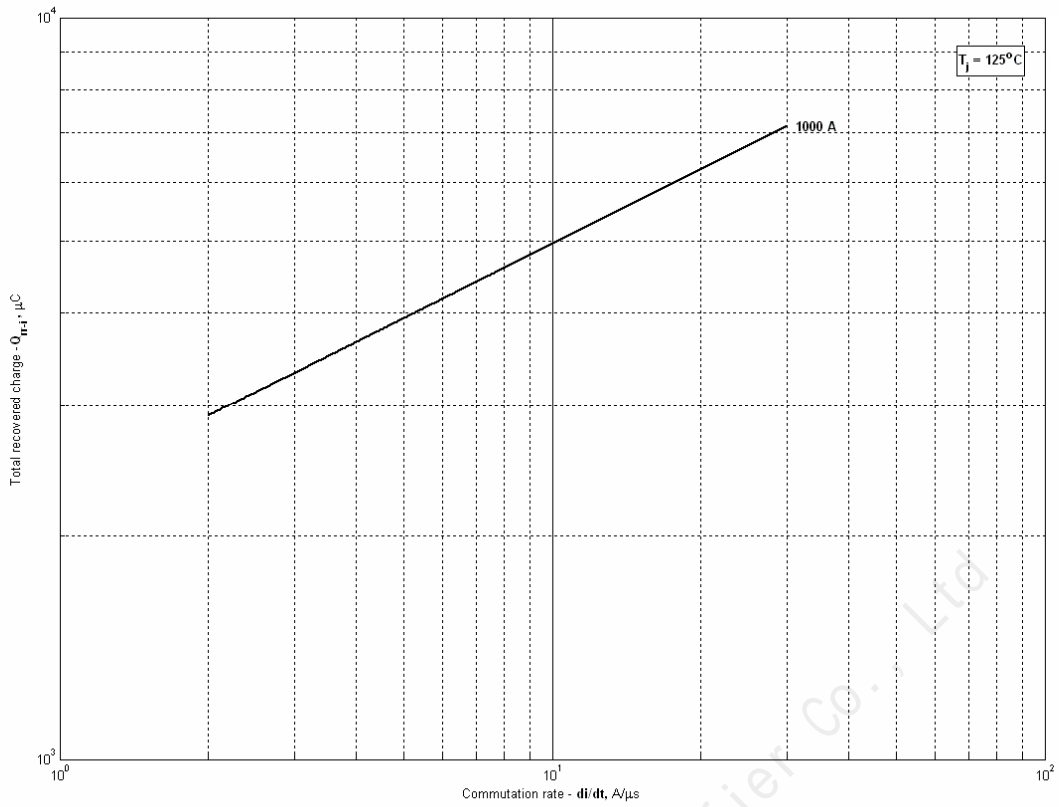
**Transient thermal impedance junction to case  $Z_{thjc}$  model (see Fig. 2)**



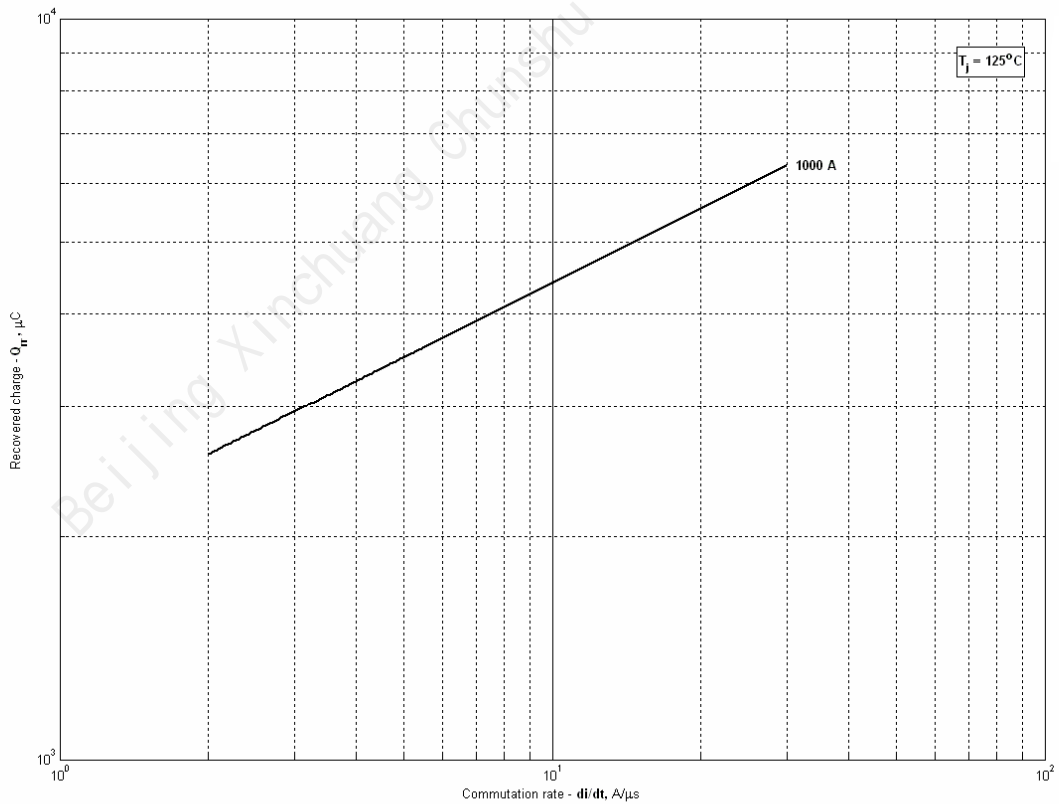
**Fig 3 – Gate characteristics – Trigger limits**



**Fig 4 - Gate characteristics –Power curves**

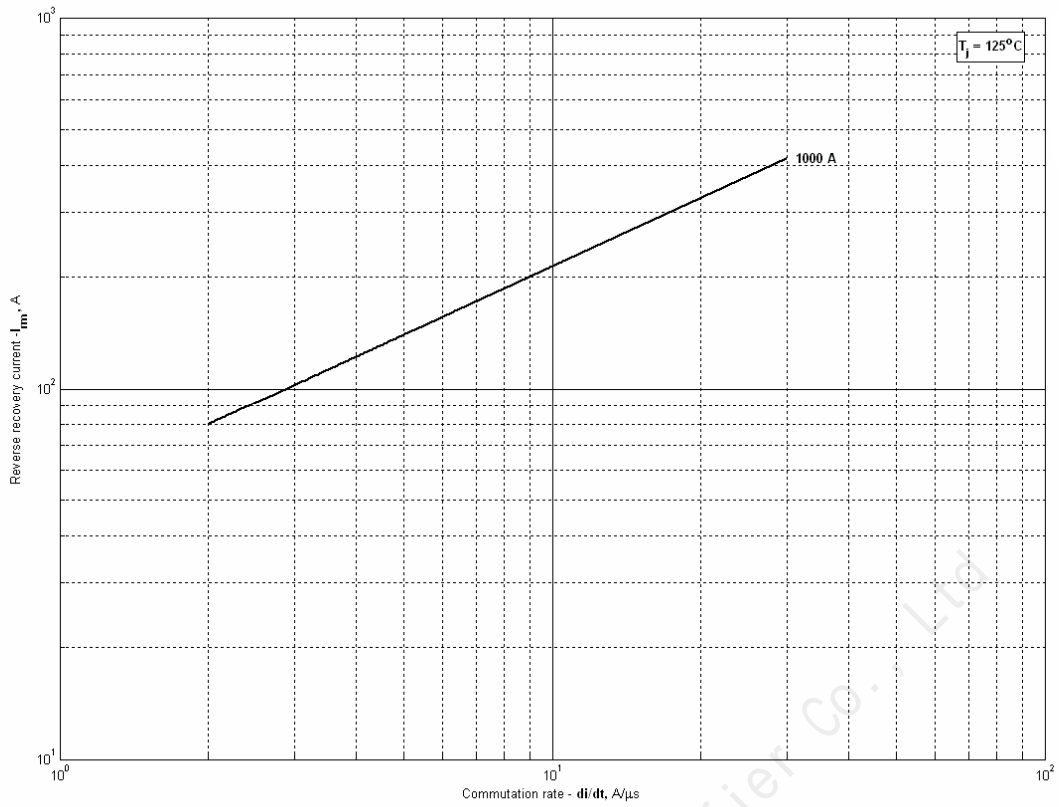


**Fig 5 – Total recovered charge,  $Q_{rr-i}$  (integral)**

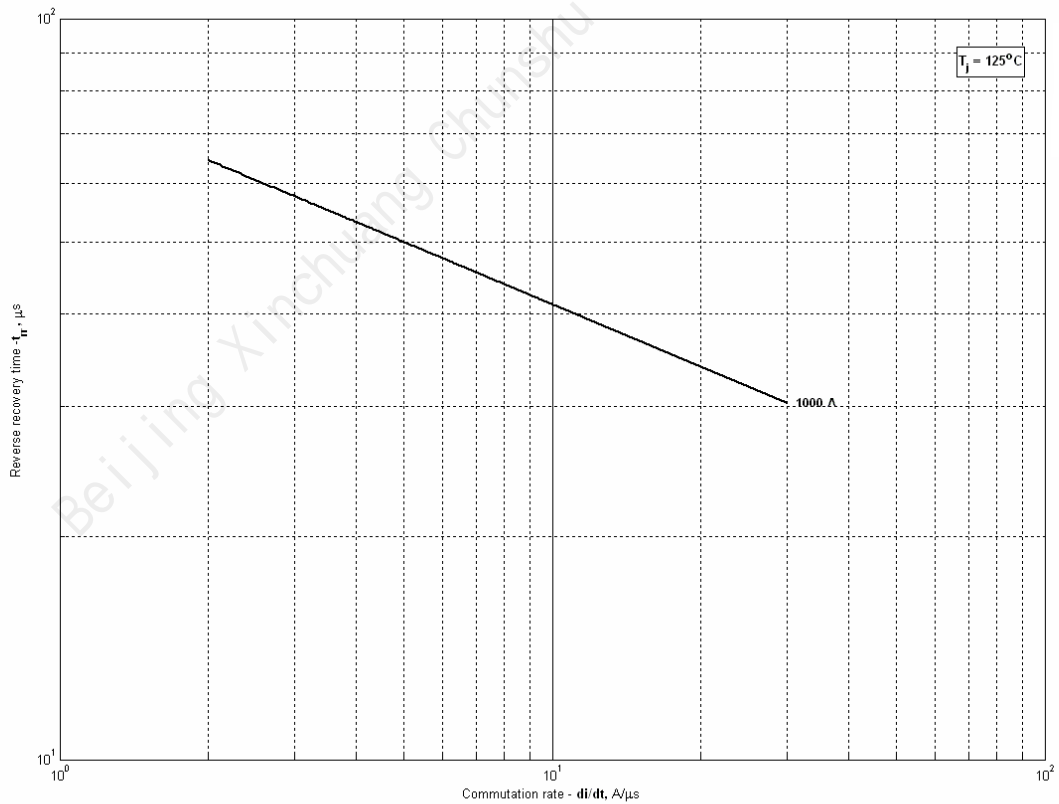


**Fig 6 - Recovered charge,  $Q_{rr}$  (linear)**

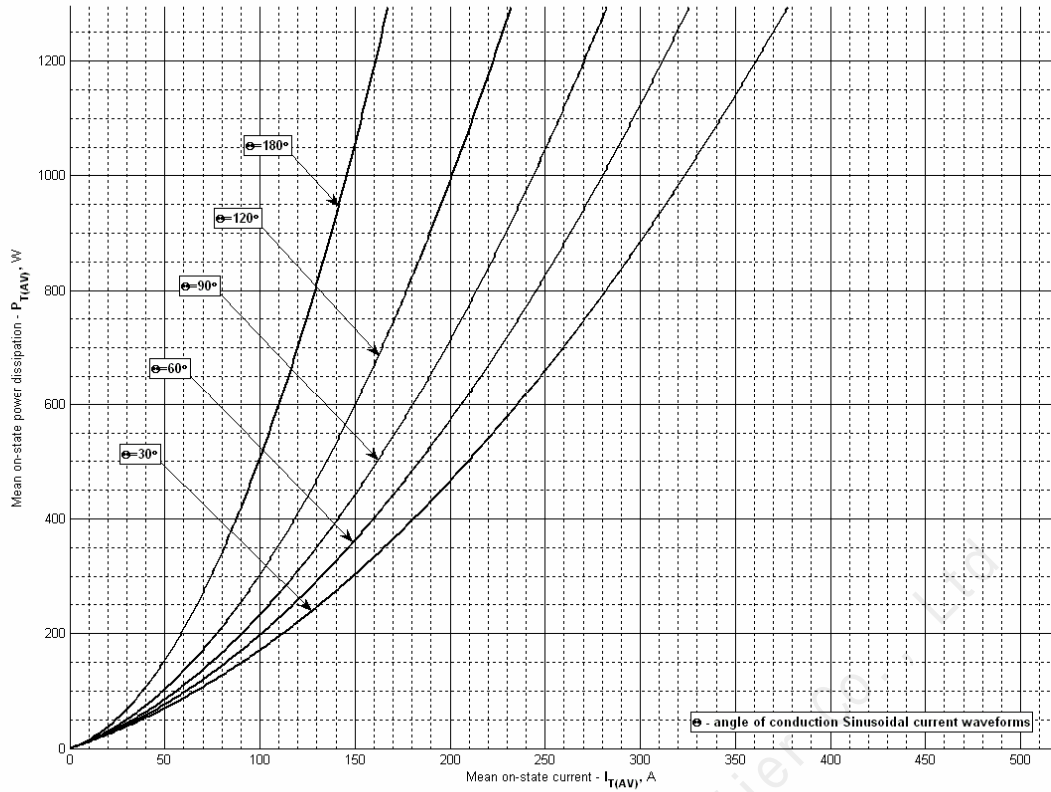




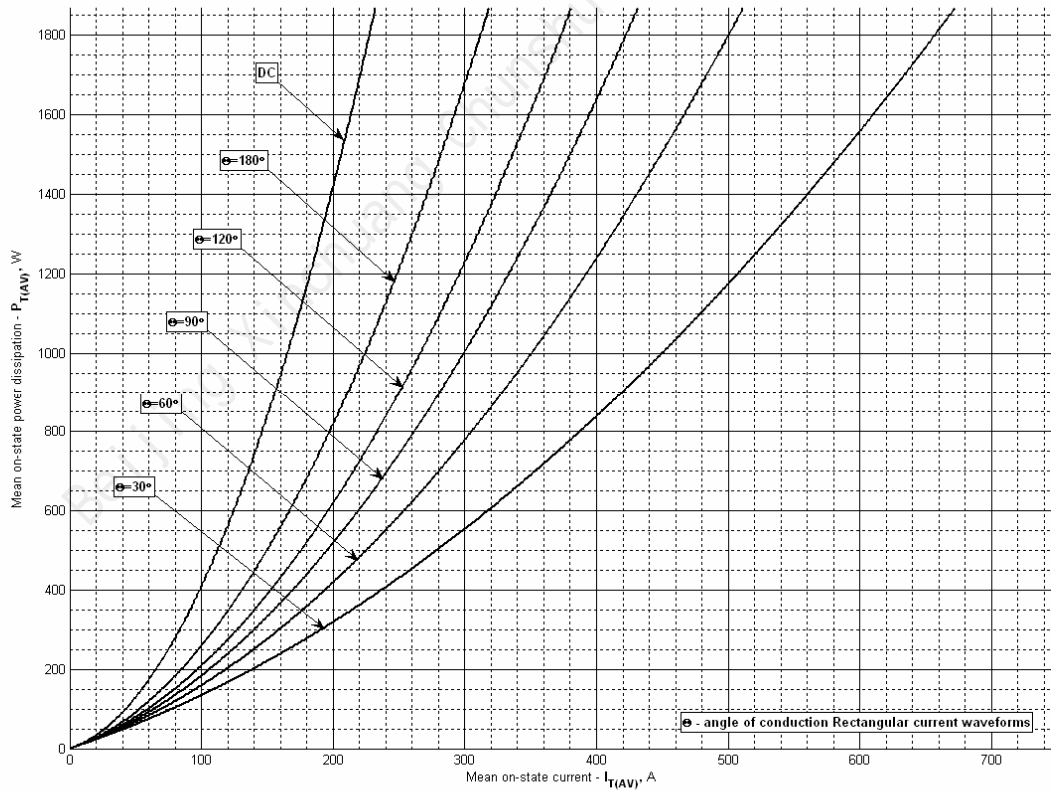
**Fig 7 – Peak reverse recovery current,  $I_{rm}$**



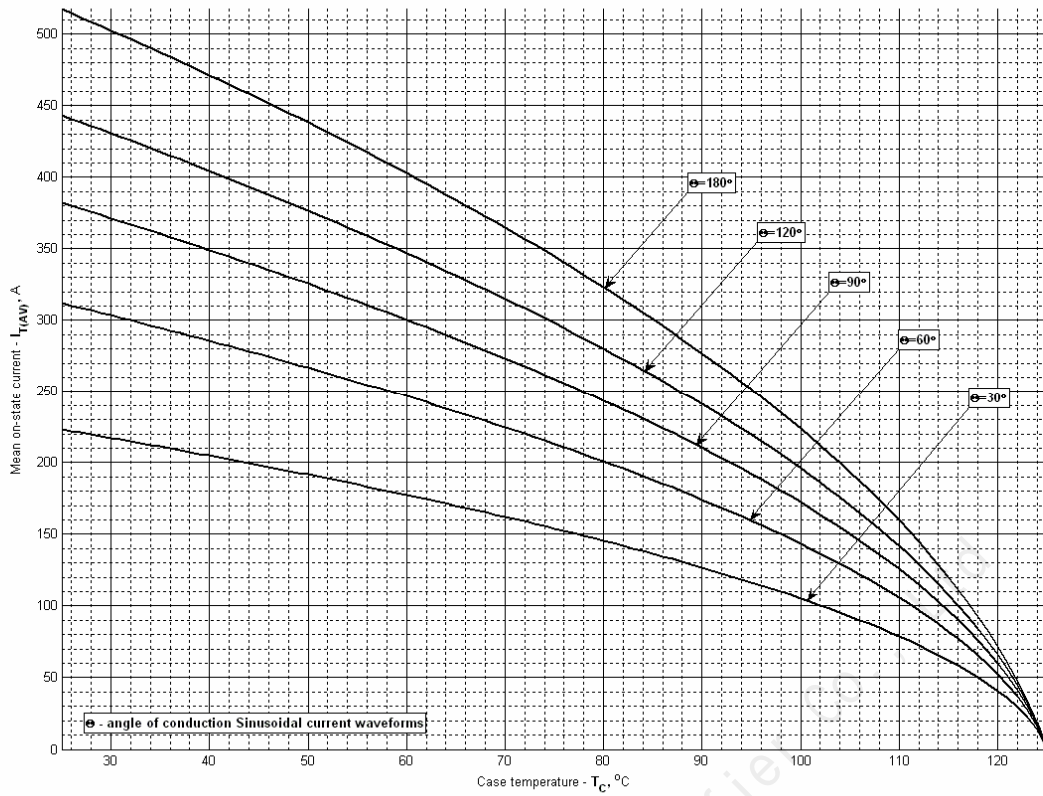
**Fig 8 – Maximum recovery time,  $t_{rr}$  (linear)**



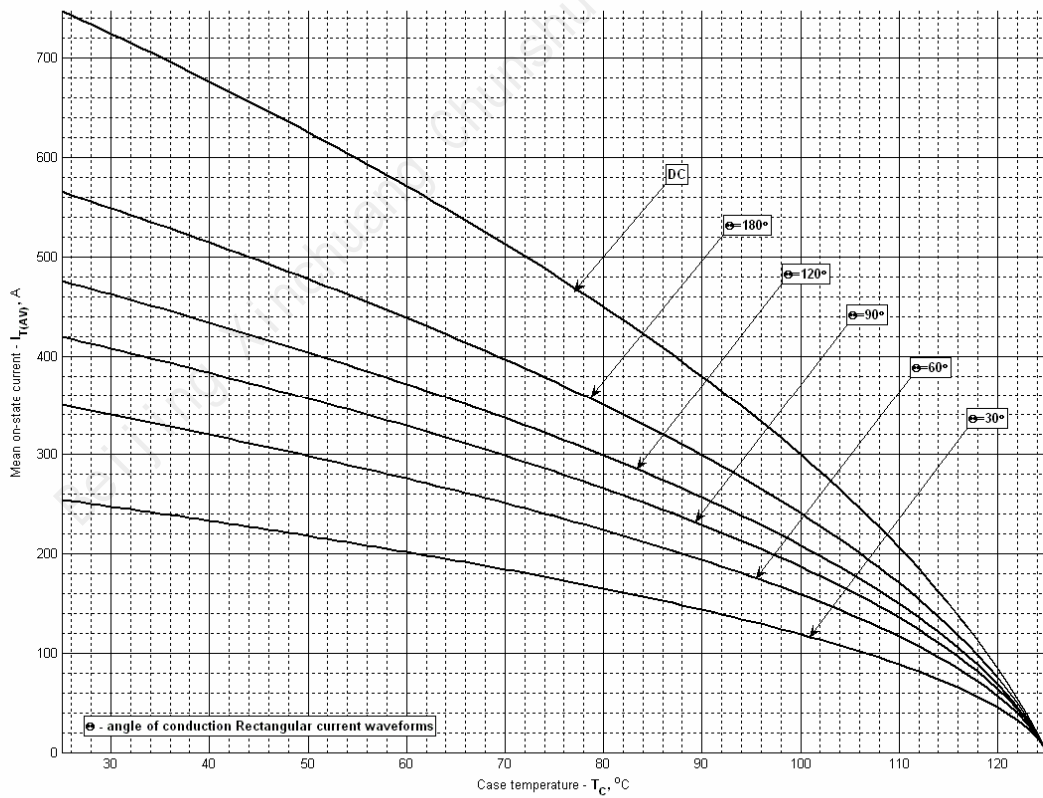
**Fig 9 – On-state power loss (sinusoidal current waveforms)**



**Fig 10 – On-state power loss (rectangular current waveforms)**



**Fig 11 – Maximum case temperature DSC (sinusoidal current waveforms)**



**Fig 12 – Maximum case temperature DSC (rectangular current waveforms)**

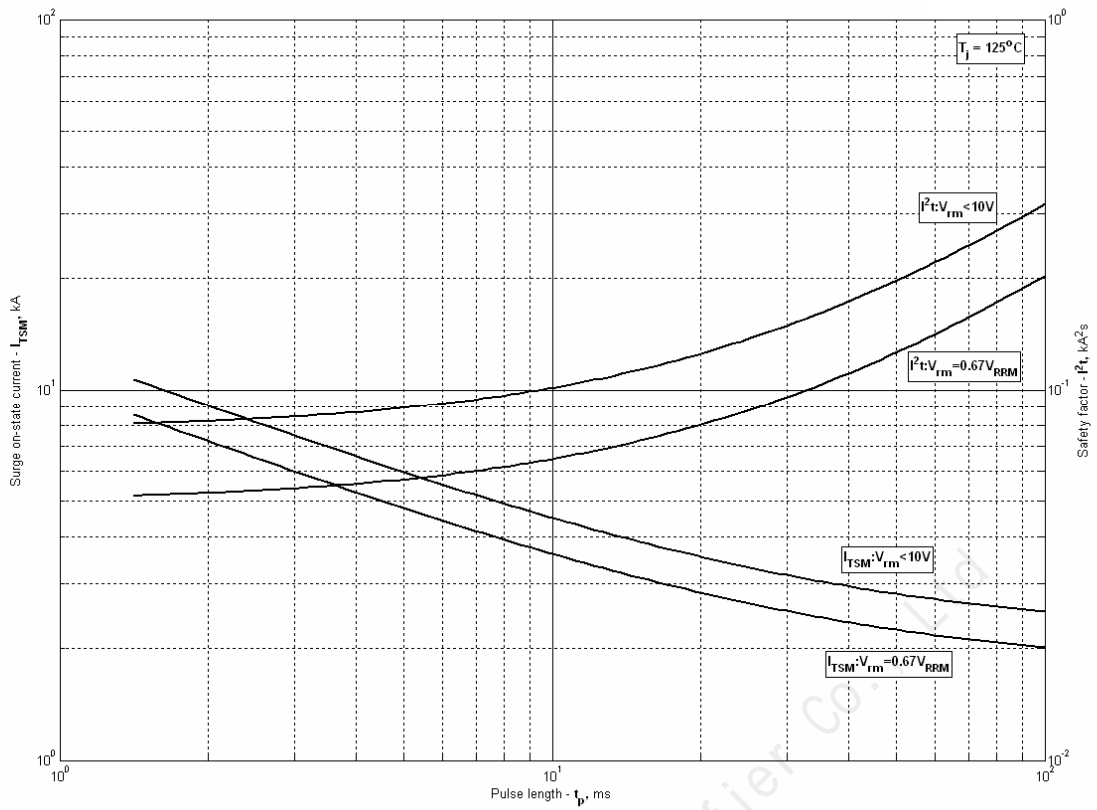


Fig 13 – Maximum surge and  $I^2t$  ratings

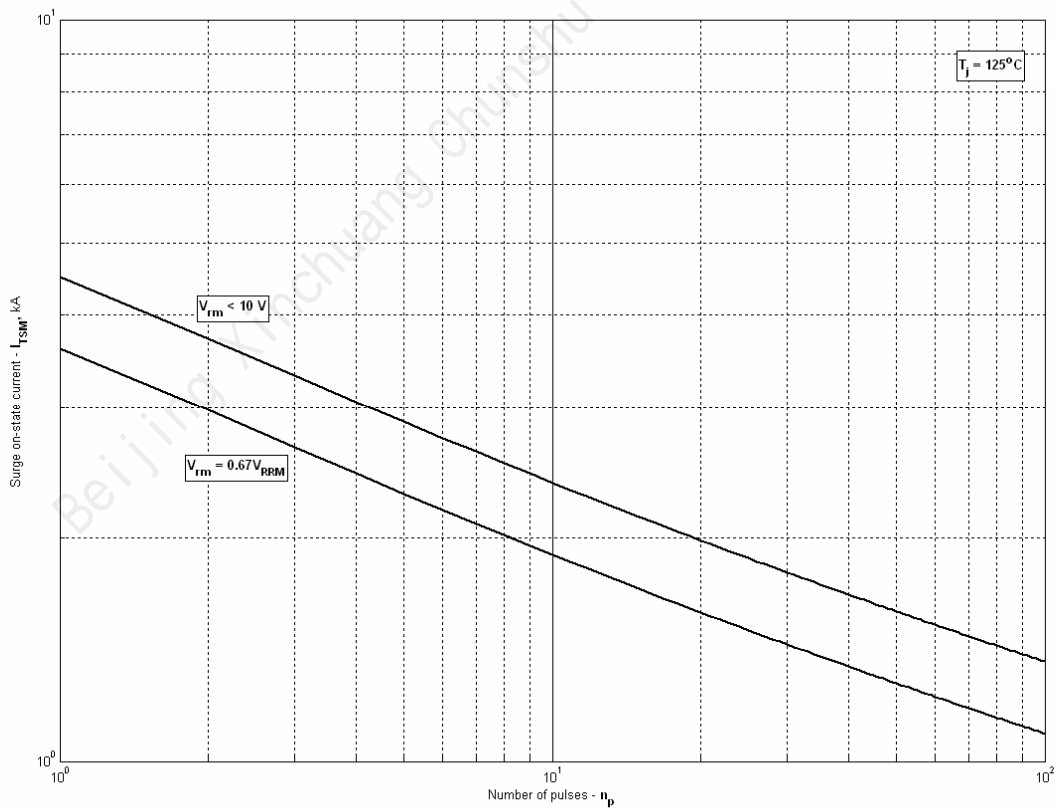


Fig 14 – Maximum surge ratings